

**PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION**

**Part Number:** [73644-1201](#)  
**Status:** **Active**  
**Overview:** [HDM®](#)  
**Description:** 2.00mm Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location A, Polarizing Key Position A, 144 Circuits

**Documents:**

[3D Model](#) [Test Summary TS-73670-990 \(PDF\)](#)  
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

**Agency Certification**

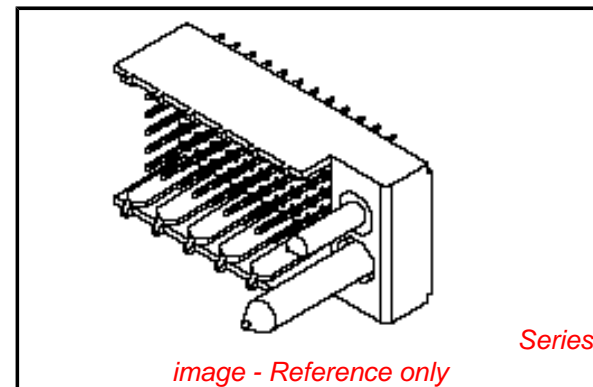
CSA LR19980  
 UL E29179

**General**

Product Family Backplane Connectors  
 Series [73644](#)  
 Application Backplane  
 Comments Standard Press-Fit  
 Component Type PCB Header  
 Overview [HDM®](#)  
 Product Name HDM®  
 Style N/A

**Physical**

Circuits (Loaded) 144  
 Circuits (maximum) 144  
 Color - Resin Black, Natural  
 Durability (mating cycles max) 250  
 First Mate / Last Break No  
 Flammability 94V-0  
 Guide to Mating Part Yes  
 Keying to Mating Part Yes  
 Material - Metal Phosphor Bronze, Stainless Steel  
 Material - Plating Mating Gold  
 Material - Plating Termination Gold  
 Material - Resin High Temperature Thermoplastic  
 Number of Columns 24  
 Number of Pairs Open Pin Field  
 Number of Rows 6  
 Orientation Vertical  
 PC Tail Length 3.50mm  
 PCB Locator No  
 PCB Retention Yes  
 PCB Thickness - Recommended 2.50mm  
 Packaging Type Tube  
 Pitch - Mating Interface 2.00mm  
 Pitch - Termination Interface 2.00mm  
 Plating min - Mating 0.762µm  
 Plating min - Termination 0.051µm  
 Polarized to PCB No  
 Stackable No  
 Surface Mount Compatible (SMC) Yes  
 Temperature Range - Operating -55°C to +105°C  
 Termination Interface: Style Through Hole - Compliant Pin



**EU RoHS** **China RoHS**

**Compliance Status**

**Not Reviewed**

**REACH SVHC**

**Not Reviewed**

**Low-Halogen Status**

**Not Reviewed**

**Need more information on product environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

**Search Parts in this Series**

[73644Series](#)

**Mates With**

[73632](#) HDM PLUS® Board-to-Board Daughtercard Receptacle. [73780](#) HDM® Board-to-Board Daughtercard Receptacle

**Application Tooling | FAQ**

*Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.*

**Global**

Description	Product #
Backplane Insertion	<a href="#">0621001400</a>
Signal Contact Tool	
Backplane Insertion	<a href="#">0622005703</a>
Head for 144 Circuits	
Flat Rock Tooling for	<a href="#">0622013700</a>
Pneumatic Press	
Extraction Tool	<a href="#">0621001000</a>

**Electrical**

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

**Material Info****Reference - Drawing Numbers**

Sales Drawing	SDA-73644-****
Test Summary	TS-73670-990

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